

Enabling Printed Electronics through Materials Design

Beng S. Ong

Institute of Materials Research & Engineering

Science & Engineering Research Council

Agency for Science, Technology and Research

and

School of Chemical & Biomedical Engineering

Nanyang Technological University

Singapore

Printed electronics promises to be much lower in cost and offers salient features such as compact, lightweight and structural flexibility characteristics. To enable printed electronics, printable materials that provide the required functionalities are needed. This presentation discusses the materials issues and design challenges, recent progress, and outlook for this emerging technology.